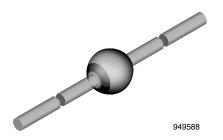


Vishay Semiconductors

Fast Avalanche Sinterglass Diode



MECHANICAL DATA

Case: SOD-64

Terminals: plated axial leads, solderable per MIL-STD-750,

method 2026

Polarity: color band denotes cathode end

Mounting position: any **Weight:** approx. 858 mg

FEATURES

- · Glass passivated junction
- · Hermetically sealed package
- Low reverse current
- Soft recovery characteristics
- Low forward voltage drop
- High pulse current capability
- Compliant to RoHS directive 2002/95/EC and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition



COMPLIANT HALOGEN FREE

APPLICATIONS

• Fast rectification diode in S.M.P.S

PARTS TABLE					
PART	TYPE DIFFERENTIATION	PACKAGE			
BYW172D	V _R = 200 V; I _{FAV} = 3 A	SOD-64			
BYW172F	V _R = 300 V; I _{FAV} = 3 A	SOD-64			
BYW172G	V _R = 400 V; I _{FAV} = 3 A	SOD-64			

ABSOLUTE MAXIMUM RATINGS (T _{amb} = 25 °C, unless otherwise specified)						
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT	
Reverse voltage = repetitive peak reverse voltage		BYW172D	$V_R = V_{RRM}$	200	V	
	See electrical characteristics	BYW172F	$V_R = V_{RRM}$	300	V	
		BYW172G	$V_R = V_{RRM}$	400	V	
Peak forward surge current	t _p = 10 ms, half sine wave		I _{FSM}	100	Α	
Average forward current			I _{FAV}	3	Α	
Non repetitive reverse avalanche energy	I _{(BR)R} = 1 A		E _R	20	mJ	
Junction and storage temperature range			$T_j = T_{stg}$	- 55 to + 175	°C	

MAXIMUM THERMAL RESISTANCE (T _{amb} = 25 °C, unless otherwise specified)					
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Junction ambient	Lead length I = 10 mm, T _L = constant	R_{thJA}	25	K/W	
	On PC board with spacing 25 mm	R_{thJA}	70	K/W	

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Forward voltage	I _F = 3 A		V_{F}	-	-	1.1	>
	I _F = 9 A		V_{F}	-	-	1.5	V
Reverse current	$V_R = V_{RRM}$		I _R	-	-	1	μΑ
	$V_R = V_{RRM}$, $T_j = 100$ °C		I _R	-	-	20	μΑ
Reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1 \text{ A}, i_R = 0.25 \text{ A}$		t _{rr}	-	75	100	ns

Vishay Semiconductors Fast Avalanche Sinterglass Diode



TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

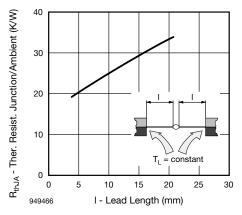


Fig. 1 - Max. Thermal Resistance vs. Lead Length

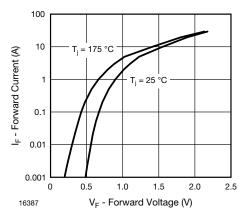


Fig. 2 - Max. Forward Current vs. Forward Voltage

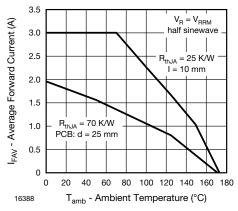


Fig. 3 - Max. Average Forward Current vs. Ambient Temperature

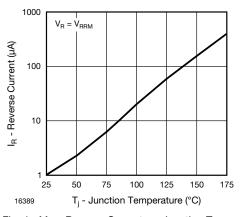


Fig. 4 - Max. Reverse Current vs. Junction Temperature

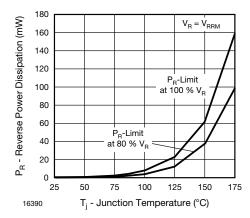


Fig. 5 - Max. Reverse Power Dissipation vs. Junction Temperature

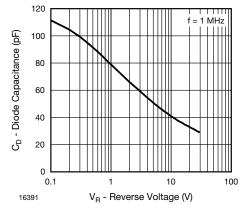


Fig. 6 - Diode Capacitance vs. Reverse Voltage



Fast Avalanche Sinterglass Diode Vishay Semiconductors

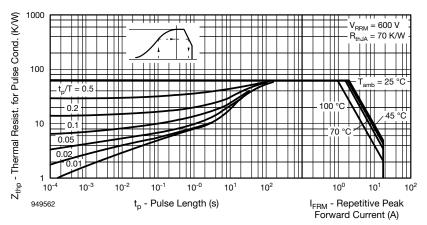
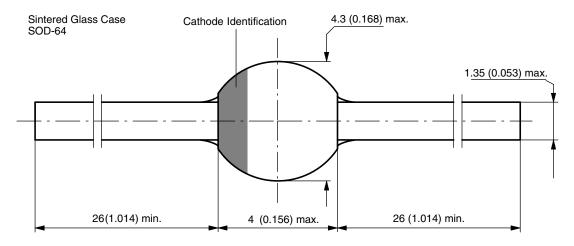


Fig. 7 - Thermal Response

PACKAGE DIMENSIONS in millimeters (inches): SOD-64



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